

1.0A SURFACE MOUNT STANDARD RECTIFIER POWERDI®323

Features

- Ultra-Small Surface Mount Package
- Low Leakage Current
- Soft, Fast Switching Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- Green Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI®323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Weight: 0.006 grams (approximate)







Bottom View

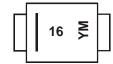
Ordering Information (Note 2)

| ſ | Part Number | Case | Packaging |
|---|-------------|--------------------------|------------------|
| | PD3R1600-7 | POWERDI [®] 323 | 3000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. For packaging details, go to our website at http://www.diodes.com..

Marking Information



16 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date Code Key

| Year | 20 | 11 | 20 | 12 | 20 | 13 | 20 | 14 | 20 | 15 | 20 | 16 |
|-------|-----|-----|-----|----------|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | \ | ′ | Z | <u>'</u> | F | ١ | [| 3 | (|) | [|) |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|--|-------|----------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 600 | V |
| Average Rectified Output Current (see figure 4) | lo | 1.0 | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 20 | А |

Thermal Characteristics

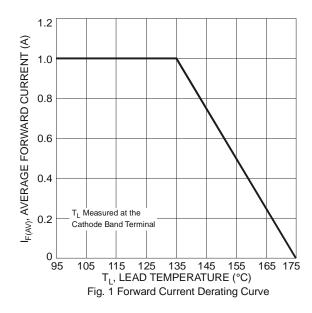
| Characteristic | Symbol | Тур | Max | Unit |
|--|-----------------------------------|--------|------|------|
| Thermal Resistance, Junction to Ambient Air (Note 3) | $R_{	hetaJA}$ | 125 | _ | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to | +175 | °C |

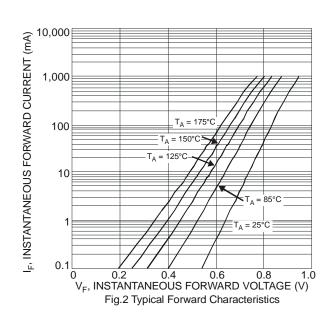
Electrical Characteristics @TA = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------------------|--------|-------------------|------|------|------|---|
| | | _ | 0.94 | _ | | $I_F = 0.5A$ |
| Forward Voltage | VF | _ | _ | 1.1 | | I _F = 1.0A |
| | | _ | _ | 0.98 | | I _F = 1.0A, T _J = 125°C |
| Leakage Current (Note 4) | | _ | _ | 1 | μΑ | $V_R = 600V$ |
| Leakage Current (Note 4) | IR | _ | _ | 50 | | V _R = 600V, T _J = 125°C |
| Tunical Payaraa Pagayary Tima | | t _{rr} — | 530 | _ | ns | $I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$ |
| Typical Reverse Recovery Time | ιrr | | | | | $I_{rr} = 0.25A$ |

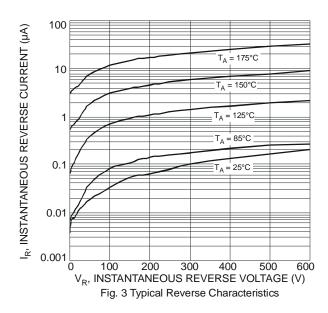
Notes:

- 3. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com. $T_A = 25$ °C.
- 4. Short duration pulse test used to minimize self-heating effect.

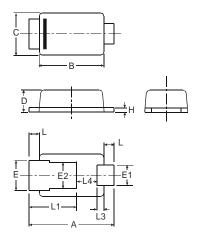






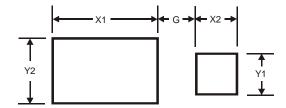


Package Outline Dimensions



| POWERDI [®] 323 | | | | | | | |
|--------------------------|------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 2.40 | 2.60 | 2.50 | | | | |
| В | 1.85 | 1.95 | 1.90 | | | | |
| C | 1.20 | 1.30 | 1.25 | | | | |
| D | 0.60 | 0.70 | 0.65 | | | | |
| Е | 0.78 | 0.98 | 0.88 | | | | |
| E1 | 0.50 | 0.70 | 0.60 | | | | |
| E2 | 0.60 | 1.00 | 0.80 | | | | |
| Η | 0.08 | 0.18 | 0.13 | | | | |
| ١ | 0.20 | 0.40 | 0.30 | | | | |
| L1 | _ | | 1.40 | | | | |
| L3 | _ | _ | 0.20 | | | | |
| L4 | 0.40 | 0.80 | 0.60 | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 0.5 |
| X1 | 2.0 |
| X2 | 0.8 |
| Y1 | 0.8 |
| Y2 | 1.1 |



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